

Resonant (NASDAQ: RESN) is creating innovative filter designs for the RF front-end, or RFFE, for the mobile device industry. The RFFE is the circuitry in a mobile device responsible for the radio frequency signal processing and is located between the device's antenna and its digital baseband. Filters are a critical component of the RFFE that selects the desired radio frequency signals and rejects unwanted signals and noise.

August 19, 2016

Sector Technology

Industry RF Semiconductor -

Integrated Circuits

Investment Highlights

- Resonant can design RF filters for mobile devices that it believes can be manufactured for half the cost and developed in half the time
- Market Growing to >\$14B by 2019
- Asset-light licensing business model keeps costs down
- More than 100 pending and issued patents
- Currently has over 10 complex filters, duplexers & quadplexers under contracted development

SELECT FINANCIALS

NASDAQ: RESN

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Fiscal Year End	Dec. 31		
Share Price (8/19/16)	\$5.36		
Market Cap (8/19/16)	\$51.5 M		
Shares Outstanding	9.6 M		
Public Float*	5.5 M		
Insider Ownership	14.7%		
Fully Diluted Shares O/S	13.9 M		

Band proliferation is driving the need for more filters

As carriers use more data bands, mobile devices need more filters creating a significant market opportunity

RF content expected to increase to ~\$22, a 30% increase.

- Barclays

ONE MODEL WITH 8 FILTERS			THREE MODELS WITH 31-35 FILTERS EACH		EXPECTED NUMBER OF FILTERS: 55 EACH
2011	2012	2013	2014	2015	2016 17
08	12 :::::	14 20 1111 18 118 1111 22 11111	35 35	31 35	555

Evolution of Filter Design – ISN®: Next Generation

Current Filter Design Utilized by Most Manufacturers

RESONANT's Infinite Synthesized Networks | ISN Fundamental | Rigorous | Scalable | Defendable

Modern Filter Image Design Acoustic Wave Acoustic Wave Theory **Network Synthesis** Ladder **RF Circuit Models** Optimization Coupling of Modes Model | COM **Empirical Optimization** & Simulation **Fundamental Physical** Simulation Models **Aggregated Physical Properties RF Circuits** RF Circuit Integration Velocity of Surface Waves Inductance | Voltage Reflectivity of Surface Waves **Fundamental Physical Properties** Density | Dimensions Fab Integration

1900s 1950s 2000s Truly State of the Art

Baseline 2014-2015 2016 2016 and Beyond **BAW Band 3 Duplexer B3** Duplexer in SAW **B3** Duplexer **Higher Complexity** in TC-SAW **Designed using COM Model Designed using ISN Designs Using ISN** • High Frequency • Comparable Performance • High Performance • High Frequency to BAW High Complexity Low Cost • Higher Complexity Lower Cost • Traditional BAW/FBAR Designs Short Development Time • Traditional BAW/FBAR Designs • Comparable Development High Cost • Much Lower Cost in SAW/TC-SAW • Long Development Times • Shorter Development Times • Essential for Higher Data rates in BAW TC SAW TC SAW TC SAW SAW SAW SAW SAW F Frequency Frequency

Business Model

- License Custom Designs for a Per-Unit Royalty and License Fees
 - No costs or overhead for manufacturing a physical product
 - Results in high operating income
- Utilize Existing Manufacturing Methods
 - No modifications or new processes required
- Rapid Design and Quick Time to Market, Expands Potential Customer Opportunities
- Retain all Intellectual Property

Resonant Inc.

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Investor Relations Contact

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Management Team & Board of Directors

Management ream & board of Directors				
NAME		SELECTED CURRENT OR PAST AFFILIATIONS		
Terry Lingren CEO, Director & Co-founder	20+ years experience as a senior technology executive; BA Physics; MSEE	KYDCERƏ QUALCOMM'		
George Holmes President, Chief Commercial Officer, Director	30+ years leadership in sales & marketing and management	Cenergous SOLARBRIDGE agere systems		
Ross Goolsby Acting CFO	25+ years financial and accounting manage- ment experience; BS Accounting	CAL>CEDA Valence de Health Tronics		
Bob Hammond CTO, Director & Co-founder	20+ years as Founder and CTO of STI; Physics Ph.D. Caltech	SUPERCONDUCTOR TECHNOLOGIES INC. LASORATORY CASCALLASORATORY		
Neal Fenzi COO & Co-founder	20+ years in engineering, operations and marketing positions at STI; BSEE	SUPERCONDUCTOR TECHNOLOGIES INC. BPACES COMMUNICATIONS SPACES COMMUNICATIONS		
John Major Chairman	Multiple board memberships with public and private high-tech companies	BROADCOM. MOTOROLA		
Tom Joseph Independent Director	Leader in the RF, semiconductor, cellular, fiber optics and SAW industries. PhD & MSEE at USC	MICRO-DEVICES		
Rick Kornfeld Independent Director	VP Engineering and leader of first CDMA effort at Qualcomm; Serial Entrepreneur	TEXAS INSTRUMENTS QUALCOMM		
Janet Cooper Independent Director	Financial expertise in capital markets, audit, tax, accounting, treasury and risk-management	TORO. LENNOX Qwest		
Michael Fox Independent Director	Financial expertise in capital markets, shareholder interests and strategy	PARK CITY CAPITAL J.P.Morgan		